

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Jingping BAO	05/13/2008
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	TYRE RESEARCH INSTITUTE OF SHANGHAI TYRE & RUBBER CO., LTD
<b>Street Address:</b>	No. 2613, Jian Chuan Road
<b>City:</b>	Shanghai
<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	29318583
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(312)277-2397
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	3125777000
<b>Email:</b>	skilbu@fitcheven.com
<b>Correspondent Name:</b>	FITCH, EVEN, TABIN & FLANNERY
<b>Address Line 1:</b>	120 South LaSalle Street
<b>Address Line 2:</b>	Suite 1600
<b>Address Line 4:</b>	Chicago, ILLINOIS 60603-3406
<b>ATTORNEY DOCKET NUMBER:</b>	8756-92761
<b>NAME OF SUBMITTER:</b>	Susan J. Kilburg
<b>Total Attachments: 1</b> source=92761Ass#page1.tif	

CH \$40.00 29318583

**ASSIGNMENT**

I, JINGPING BAO, of Shanghai, CHINA, for good and valuable consideration, receipt of which is hereby acknowledged, have assigned and do hereby assign to THE TYRE RESEARCH INSTITUTE OF SHANGHAI TYRE & RUBBER CO., LTD, a Chinese Company, having its principal place of business at No. 2613, Jian Chuan Road, Shanghai, CHINA, its successors, assigns and legal representatives, the entire right, title and interest, in and to all subject matter invented by us and disclosed in the application for Letters Patent of the United States entitled:

**TIRES**

United States Application Number 29/\_\_\_\_\_, filed May \_\_, 2008; and in and to all Letters Patent and all Convention and Treaty rights of all kinds, and all rights in and to any continuation, continuation-in-part, and divisional application therefrom, and any reissue or re-examination as to any Letters Patent issuing therefrom, including the right to claim priority from said application, in all countries throughout the world, for all such subject matter described therein, including all rights of action and rights to recover damages for past infringements. I agree to sign all documents necessary to secure all said Letters Patent and rights, and request issuance of all said Letters Patent to the above assignee in accordance with this Assignment.

May 13, 2008

包静萍  
JINGPING BAO